

thin film components | better magnetic design | integrated solutions | OEM support | process specific

gencoa: perfect your process

intelligent plasma monitoring and feedback

Cracker valve and plasma control process for reactive sputtering with Selenium & Sulphur



Victor Bellido-González, Dermot Monaghan, Benoit Daniel, Joseph Brindley, Gencoa Ltd, UK

Dr. Iván Fernández-Martínez, Ambiörn Wennberg

nano4ENERGY

Fernando Briones

CSIC
CONSEJO SUPERIOR DE INVESTIGACIONES CIENTÍFICAS

Raquel Gonzalez, Pedro Melgar

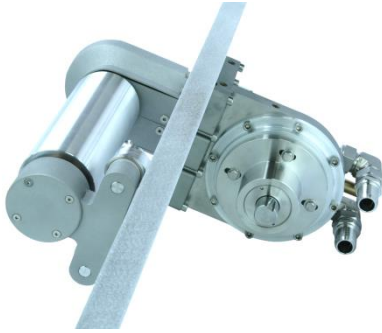


thin film and
pvsolutions
products. process. support



GENCOA current products cover 3 sputtering related areas

gencoa: perfect your process



planar & rotatable
**Magnetron Sputter
Cathodes and
Magnetic Systems**



**Reactive gas
controller
& endpoint
detector**

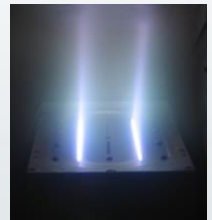


**Linear
ion sources**

*Other activities include on-site process
implementation, training and tuning*



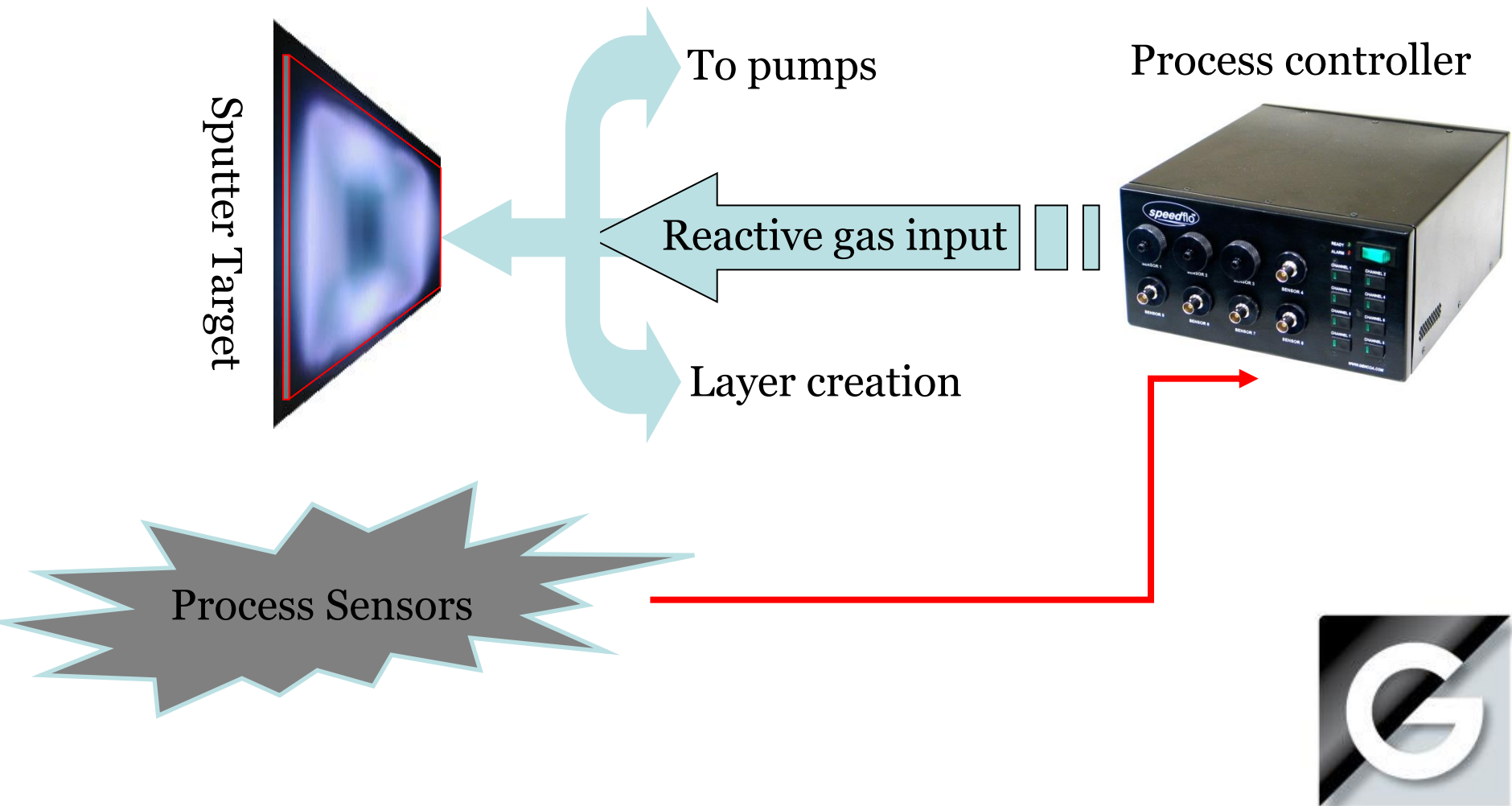
- Introduction to reactive sputtering
- Existing CIGS processing routes and one system concept
- Feedback control and cracker design
- Reactive sputtering of sulphur and selenium based layers with Cu, In & Zn target materials
- Conclusions



Reactive Sputtering is highly unstable, but advanced control makes widespread

gencoa: perfect your process

production process in many sectors





Objective is to bring established high volume flexible process to delivery of calcogens for CIGS layers

gencoa: perfect your process

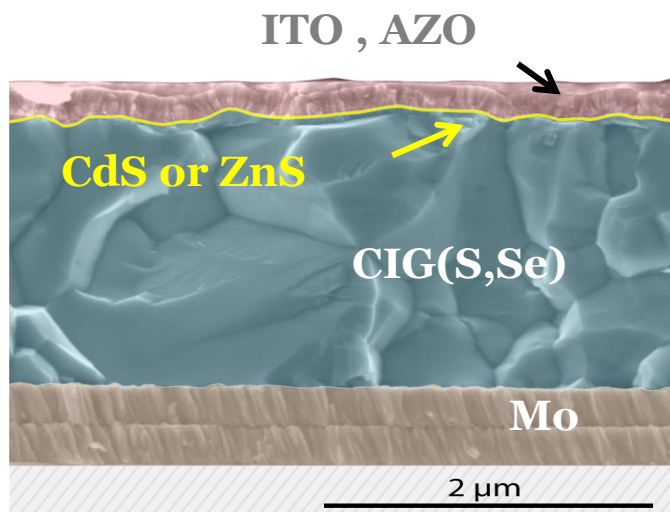
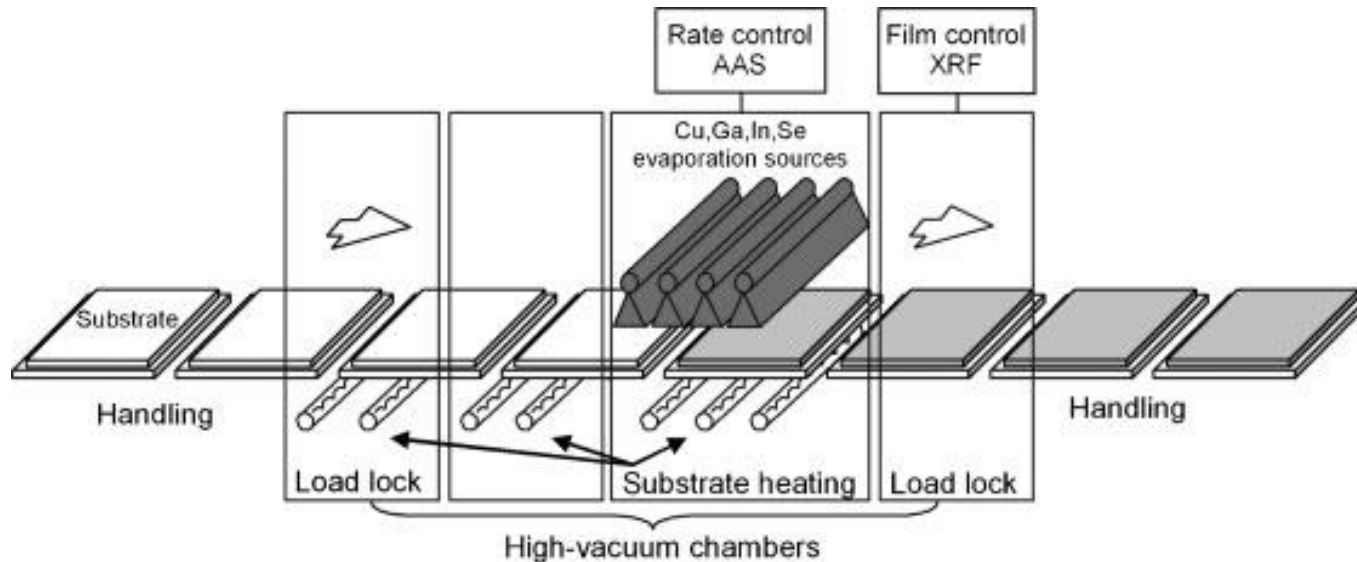
Key technology requirement in order to implement this is the delivery of the solid Se & S species to the reactive process environment at high speed - in the vapor phase - main topic of this presentation.



The attraction of the reactive sputtering route has been recognised and

genco: perfect your process

several companies have sought success



Solyndra, Miasole, Daystar have all pursued and implemented the reactive sputtering method, but due to technical and commercial challenges all have failed.

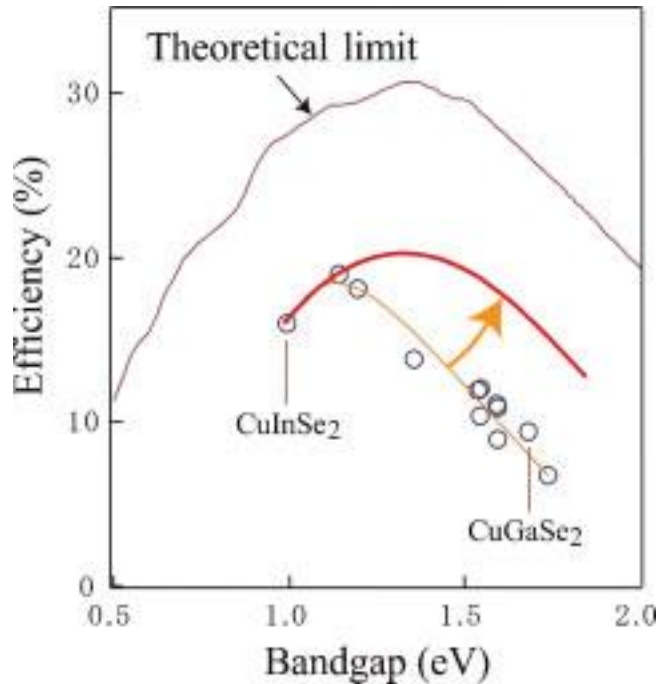
Older more established technologies of evaporation and sputtering with a 2nd stage selenization and sulphurization have won out – FOR NOW!



But it is accepted that the existing technologies cannot approach the

gencoa: perfect your process

theoretical maximum efficiencies of 30%



In order to achieve the higher efficiencies total flexibility to readily change layer compositions and layer combinations with a reliable process is required.

A pure sputter based approach can achieve this so long as the current challenges of the Se and S delivery are overcome.

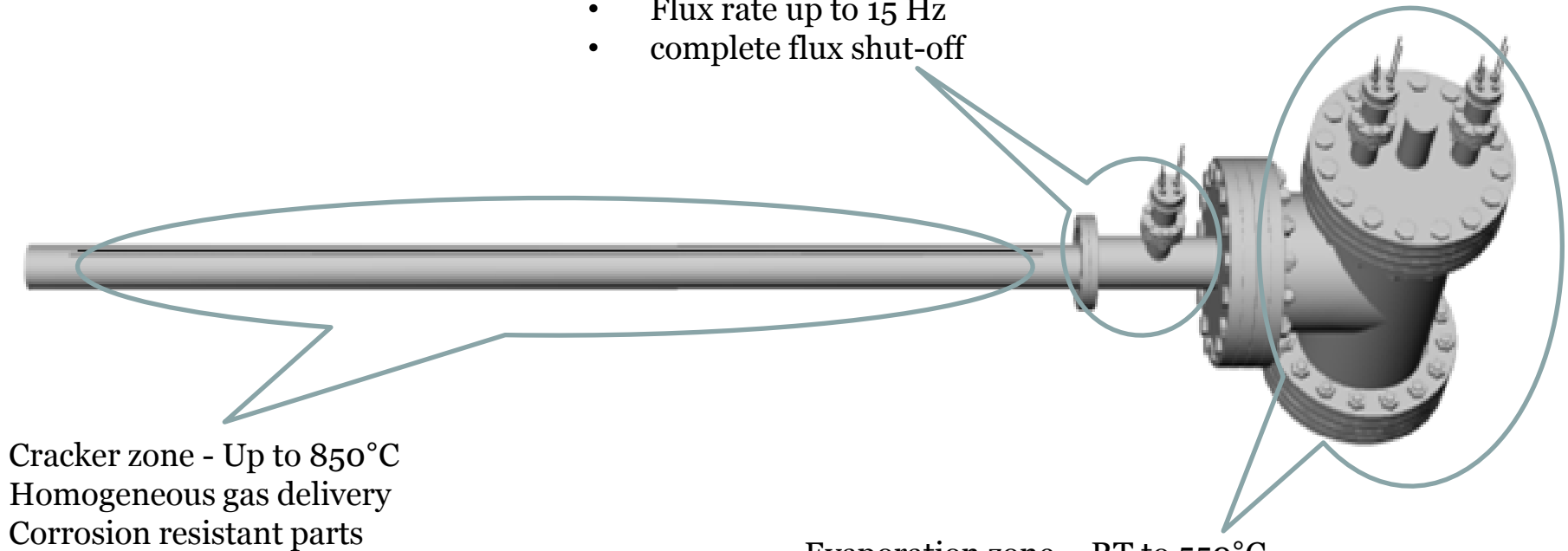
I 'believe' that the biggest technical challenge that faced Solyndra, Daystar and possibly Miasole, was lack of good control of the Se and S gas combined with lack of a fast feedback and precise dosing method.



Principle of the gas delivery units – pulsed cracker valve – patent pending

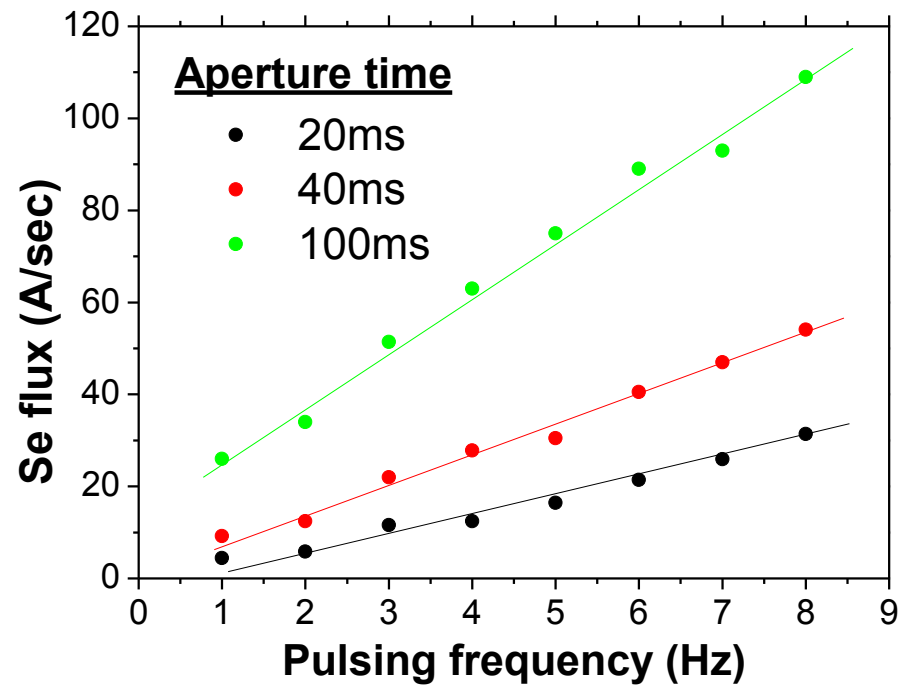
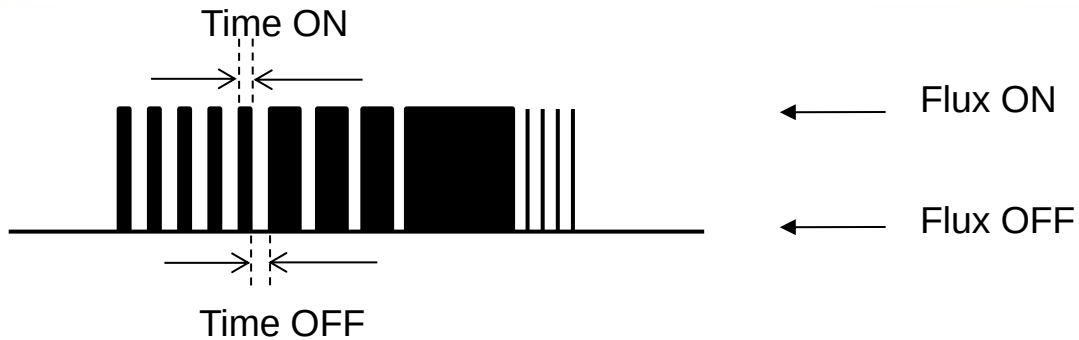
gencoa: perfect your process

- Hermetic fast
actuating valve
- Fluxes from 20 msec
 - Flux rate up to 15 Hz
 - complete flux shut-off



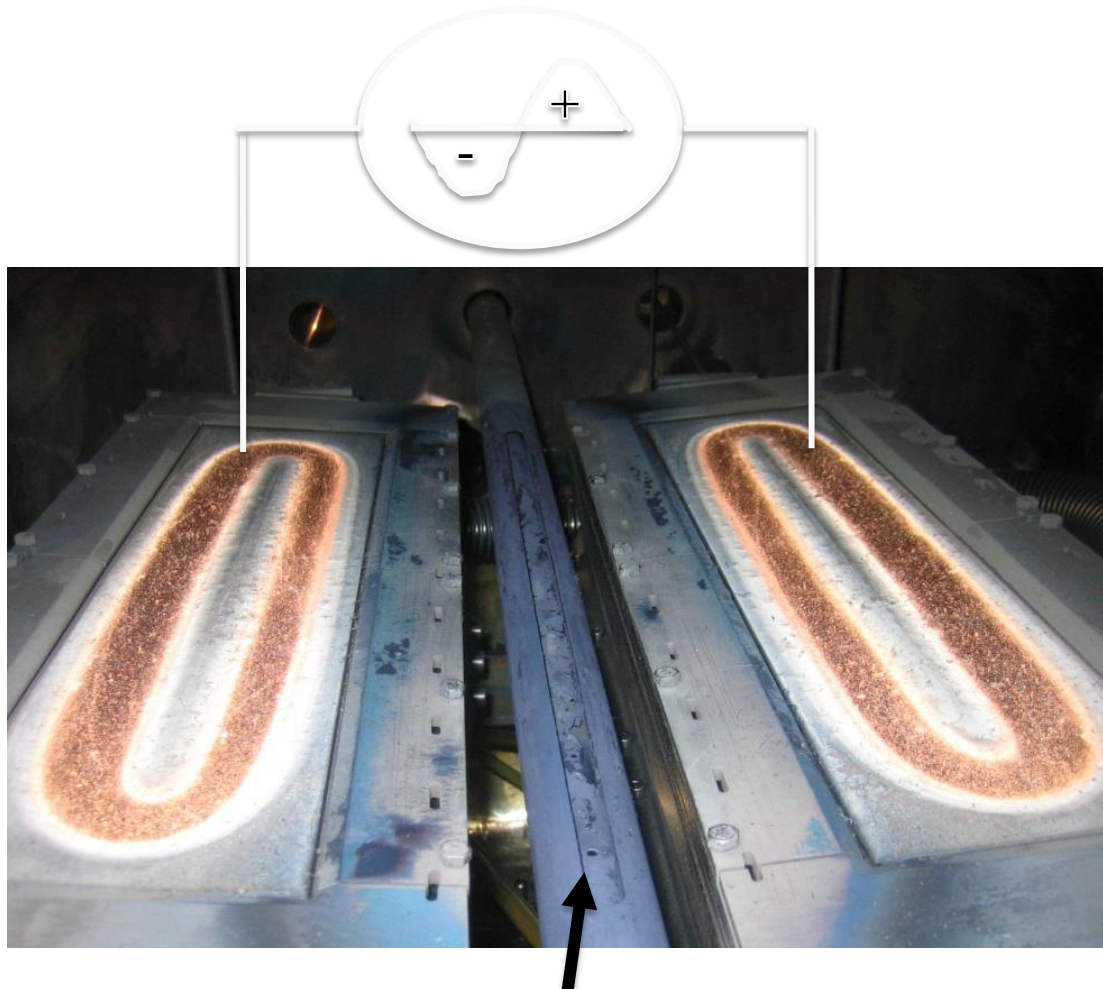
Operation principle: pulsed mode

gencoa: perfect your process



Test setup – 2 x planar magnetrons 0.5m long with MF power

gencoa: perfect your process

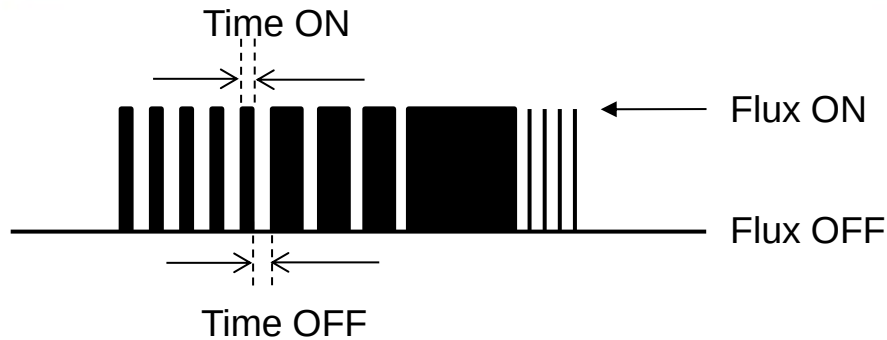


Effusion cell cracker for
reactive gas injection



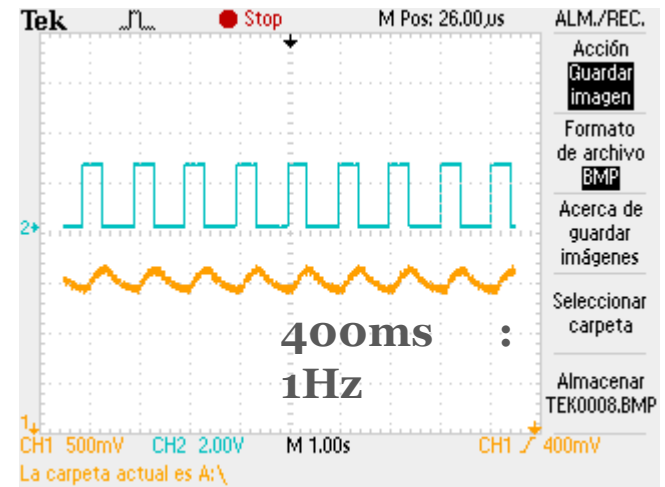
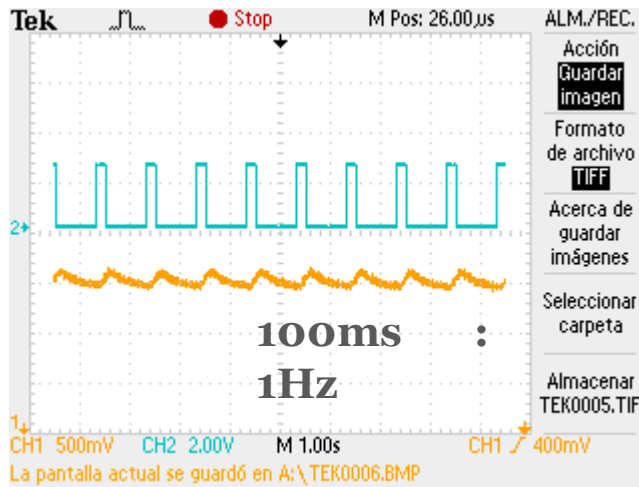
Response of the valve and target condition with varying pulse widths

gencoa: perfect your process



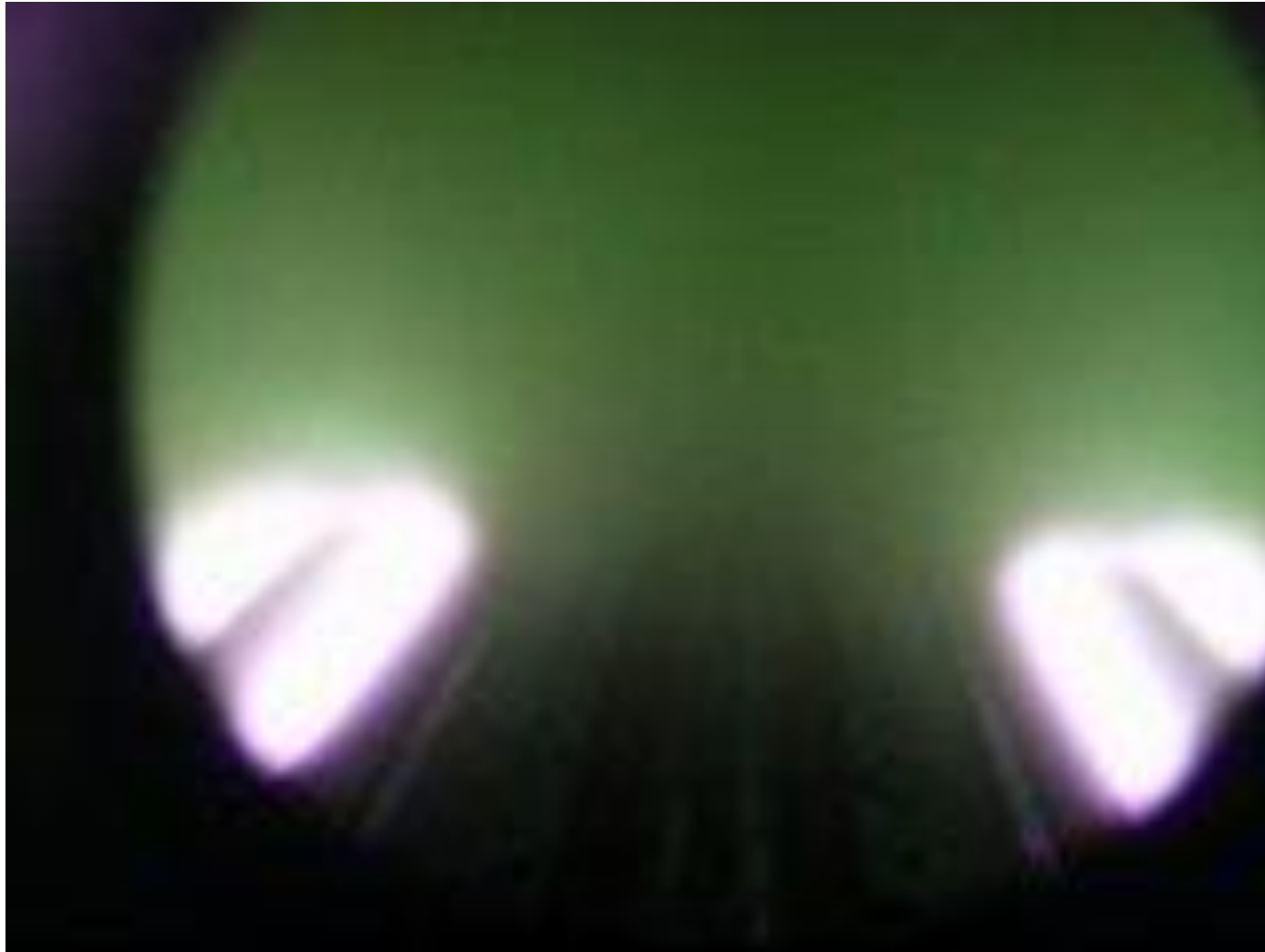
Valve actuator

Target voltage response



Video of plasma appearance with Se pulse gas input

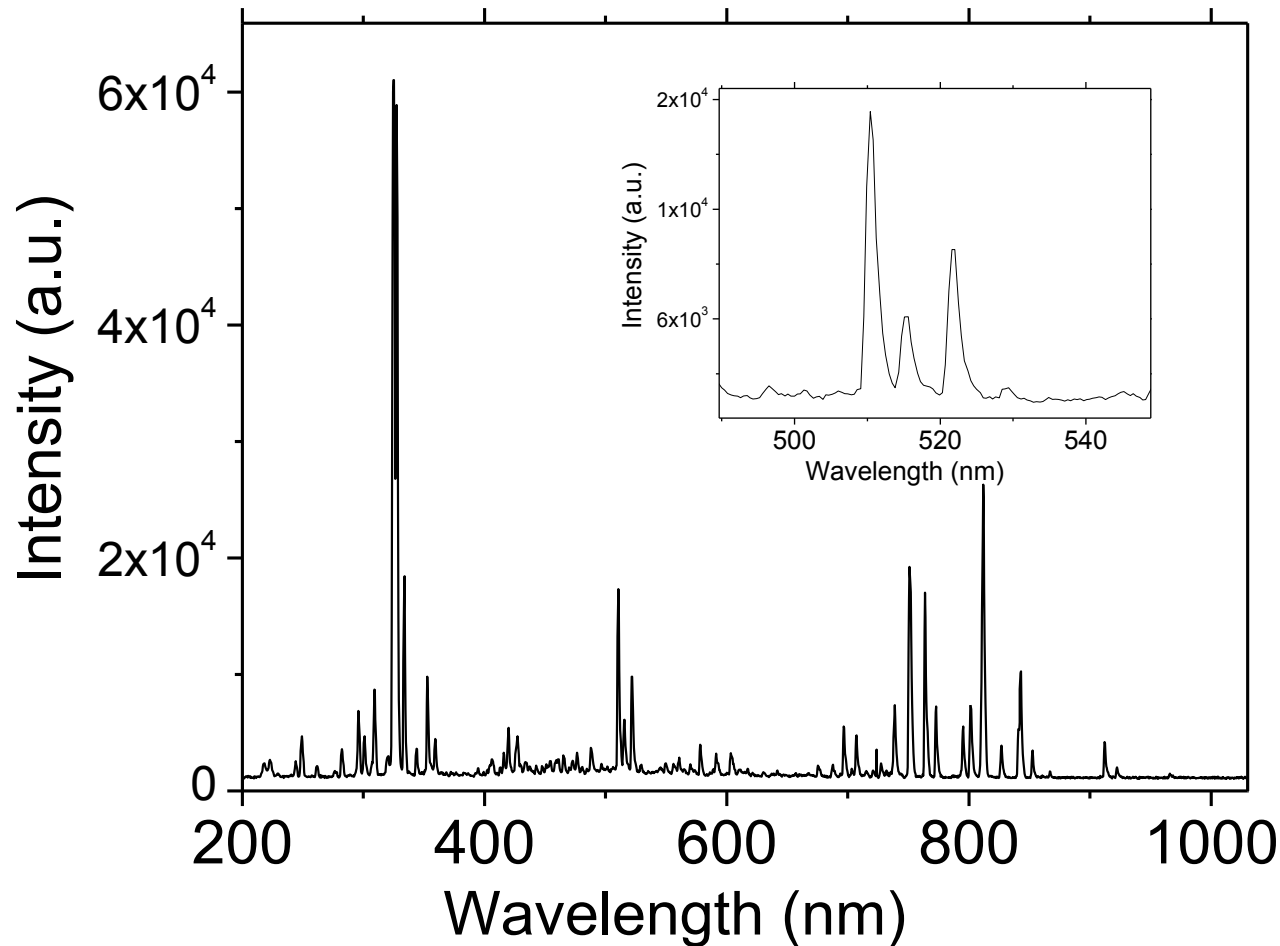
gencoa: perfect your process



Plasma optical emission spectrum with pure copper (inlaid graph) & with Cu

gencoa: perfect your process

combined with Sulphur (main graph)



Cu I

510.5 nm

515.3 nm

521.8 nm



Having a fast and stable Se & S delivery system completes the cycle required for

gencoa: perfect your process

total control of the process



**SENSOR
INPUTS**



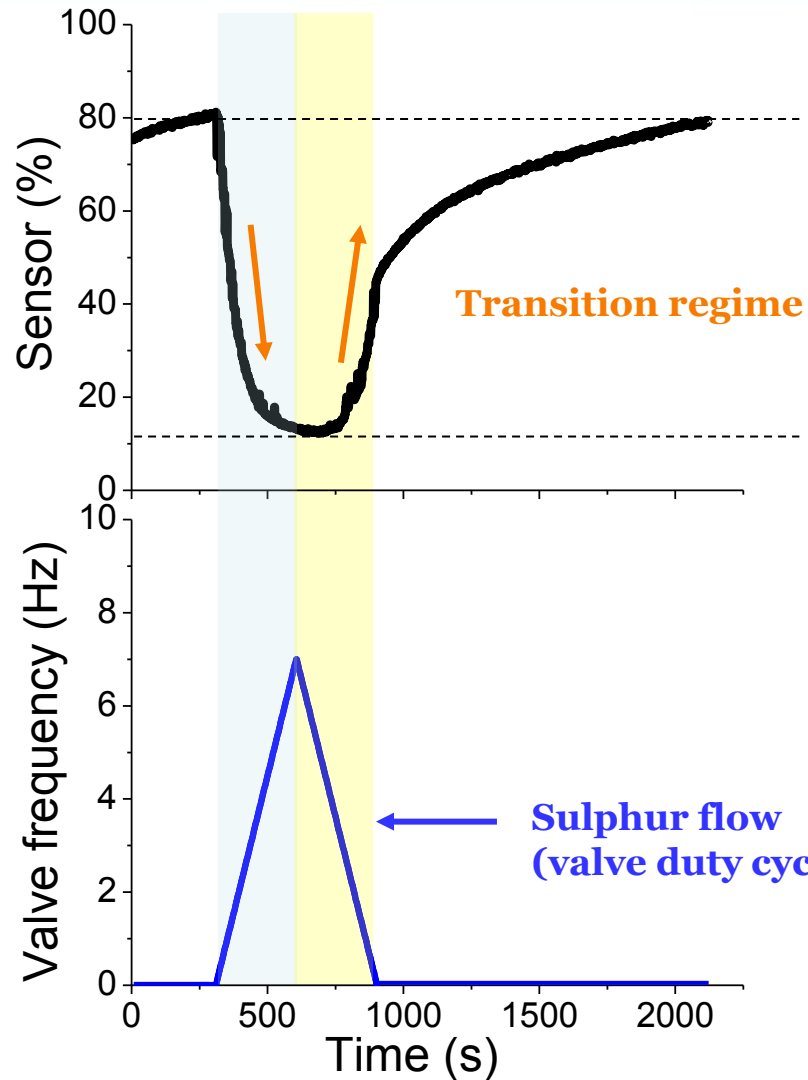
**ACTUATOR
OUTPUT**



**REACTIVE GAS
INJECTION**



gencoa: perfect your process



'Metal'

λ Sensor (CCD) = **510.8nm**
(Cu)

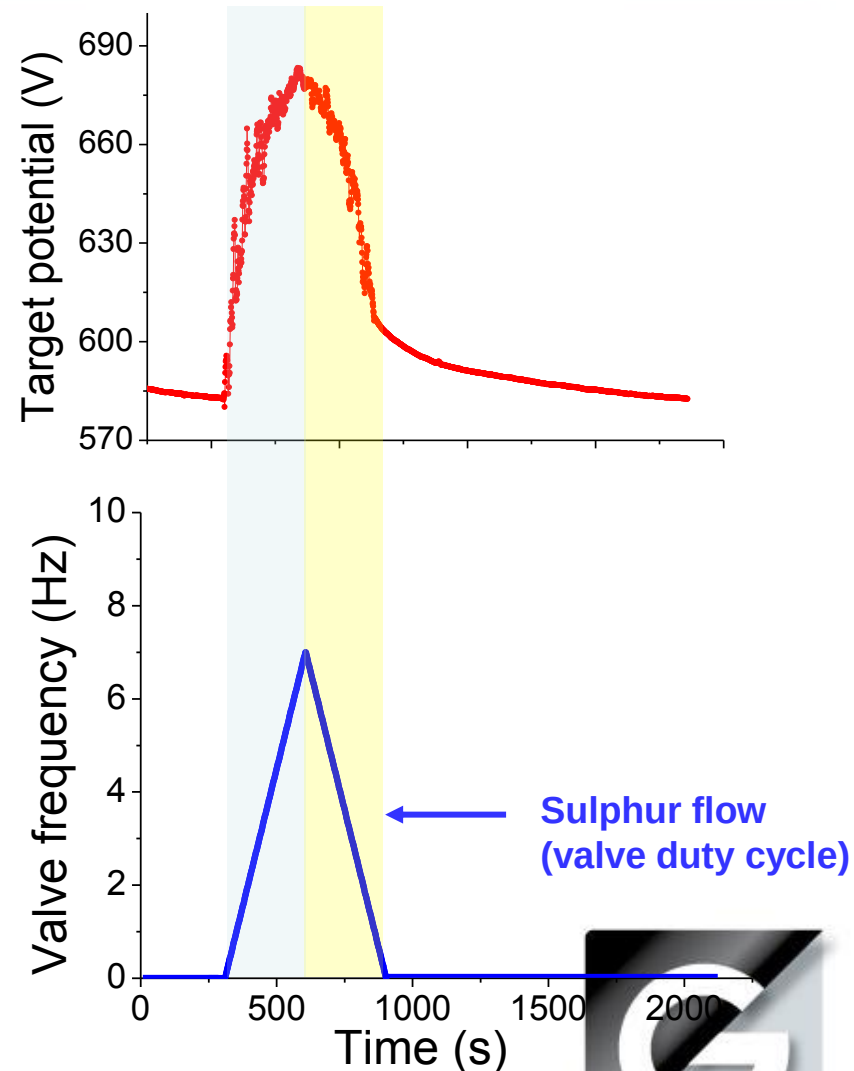
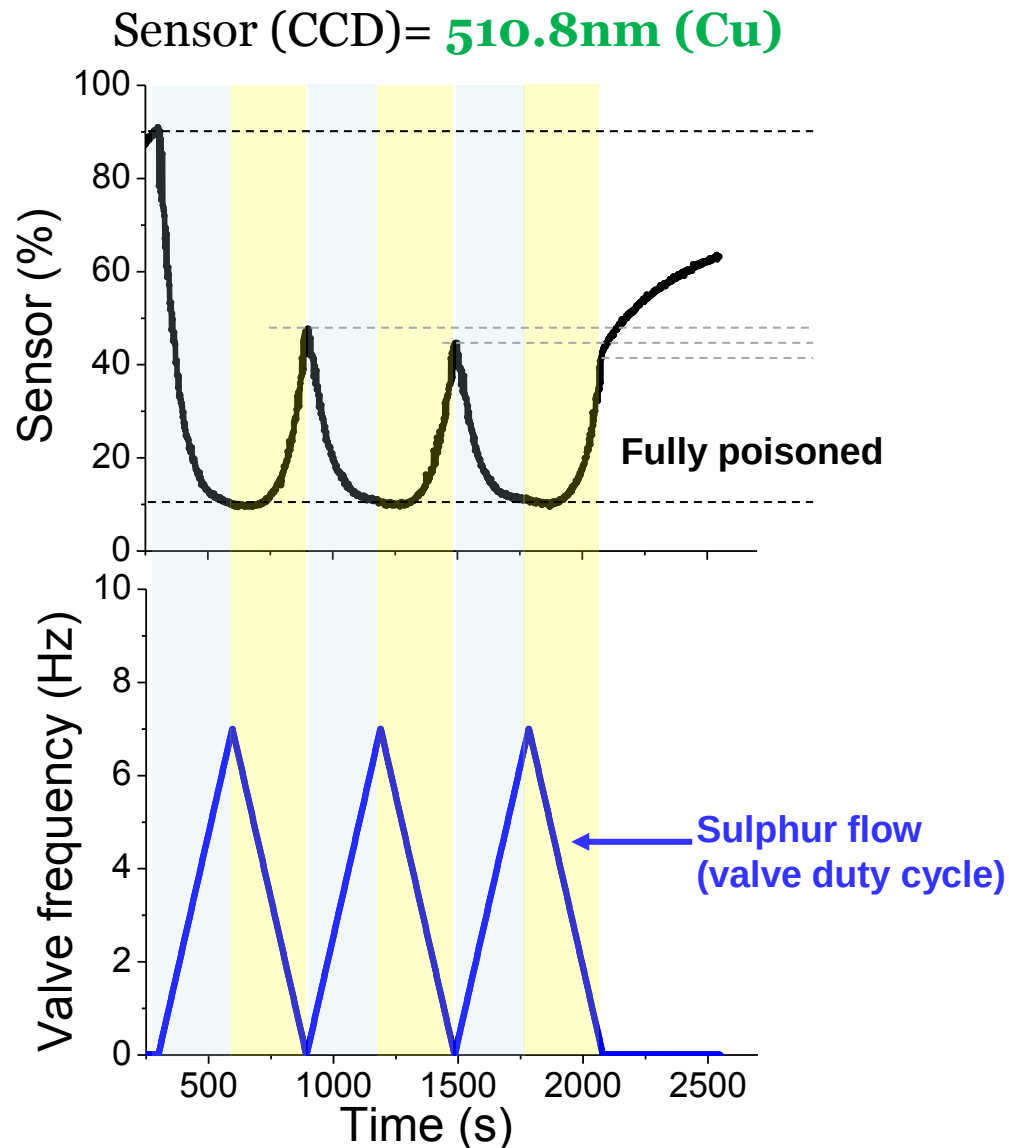
Fully poisoned



Hysteresis ramps: P.E.M. & target voltage, displays classic reactive sputtering

gencoa: perfect your process

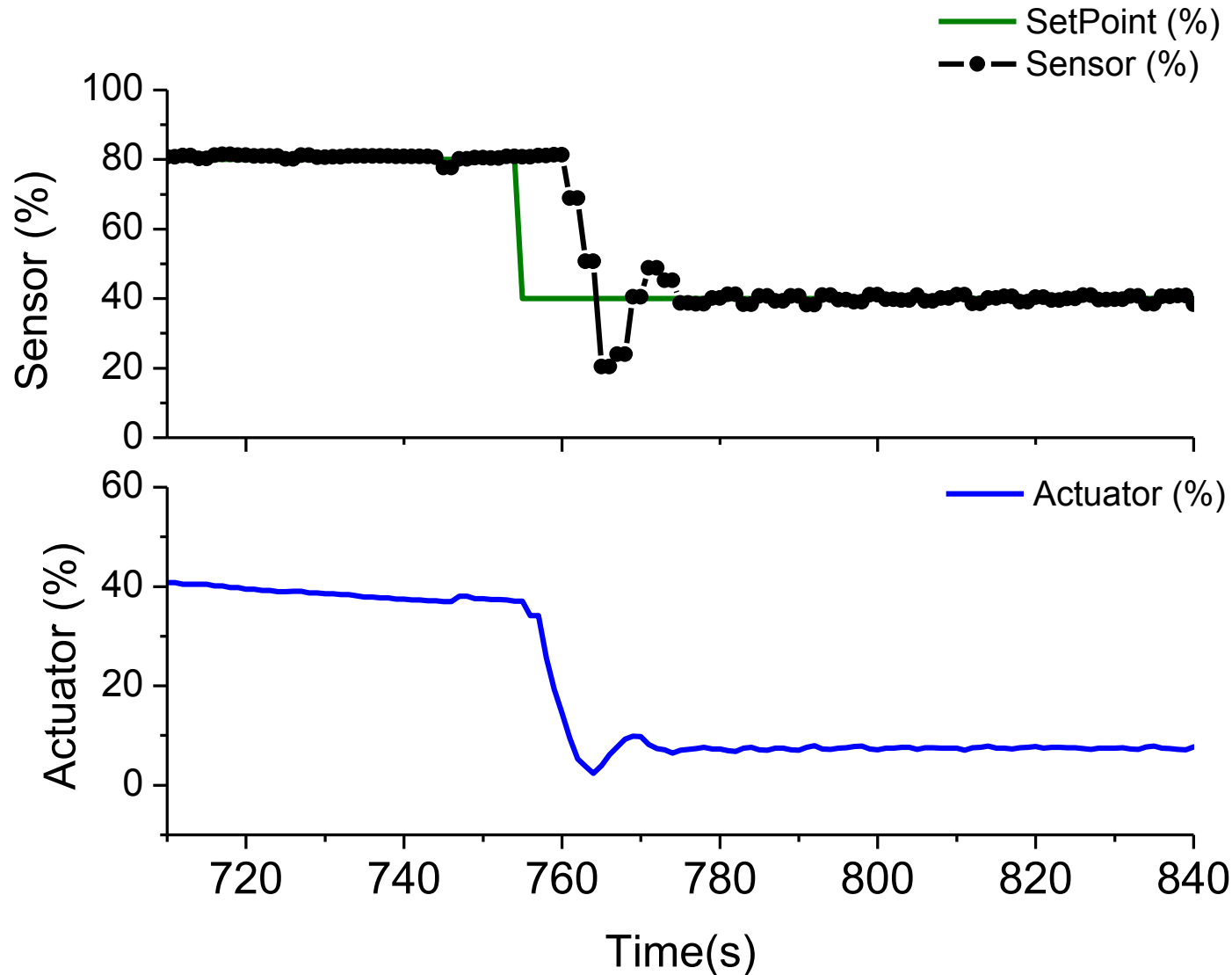
behaviour which indicates needs feedback control



Example of Selenium flow adjustment via feedback control of the pulsed

gencoa: perfect your process

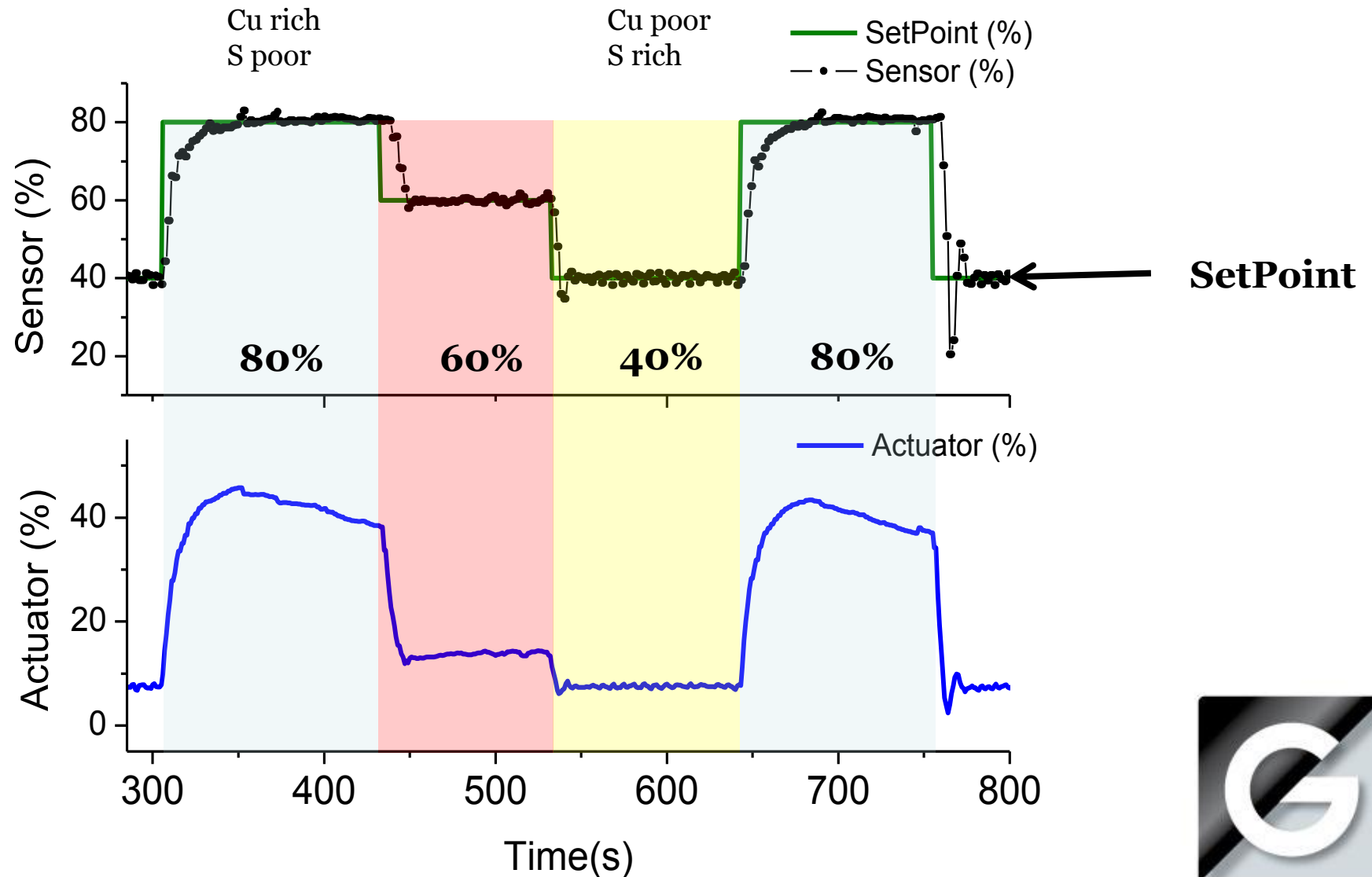
cracker valve by plasma emission sensing of Se



Active feedback control – changing set-points and controlling compositions at

gencoa: perfect your process

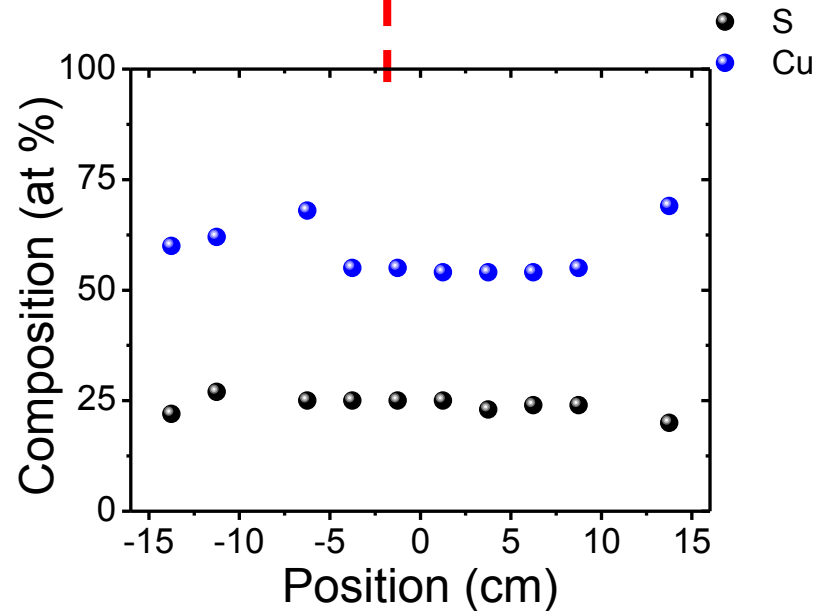
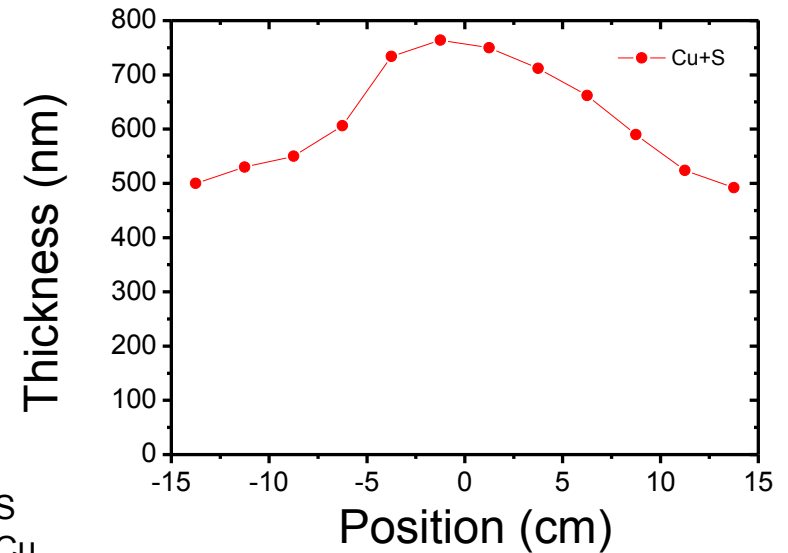
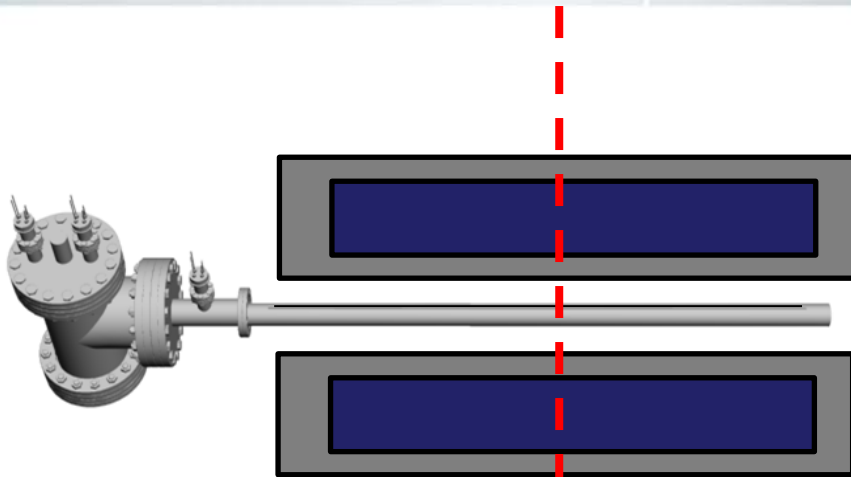
different levels to demonstrate control



Thickness and composition distribution for a Copper Sulphide

gencoa: perfect your process

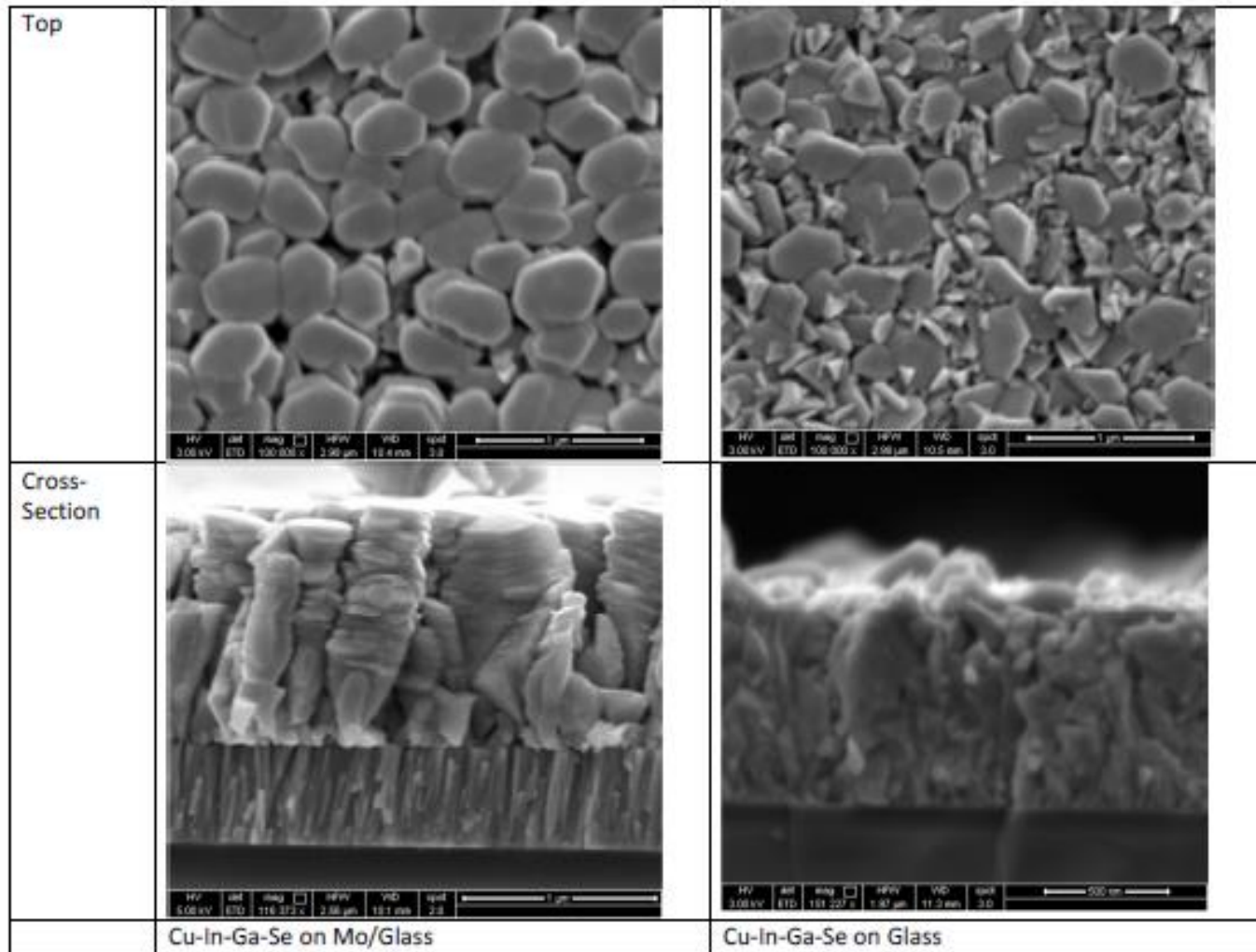
combination of materials



Example of reactively sputtered CuInGaSe_2 structure - No serious

genco: perfect your process

layer or cell development to be performed

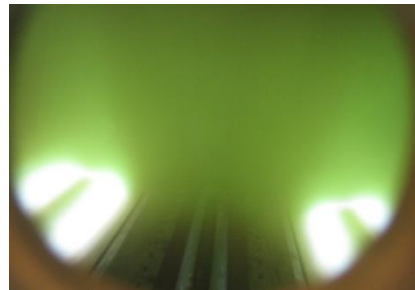


Plasma emission spectrums for In, Cu & Zn in the presence of Sulphur

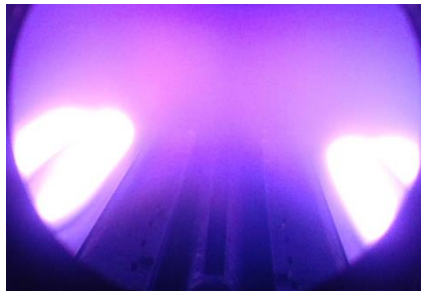
gencoa: perfect your process



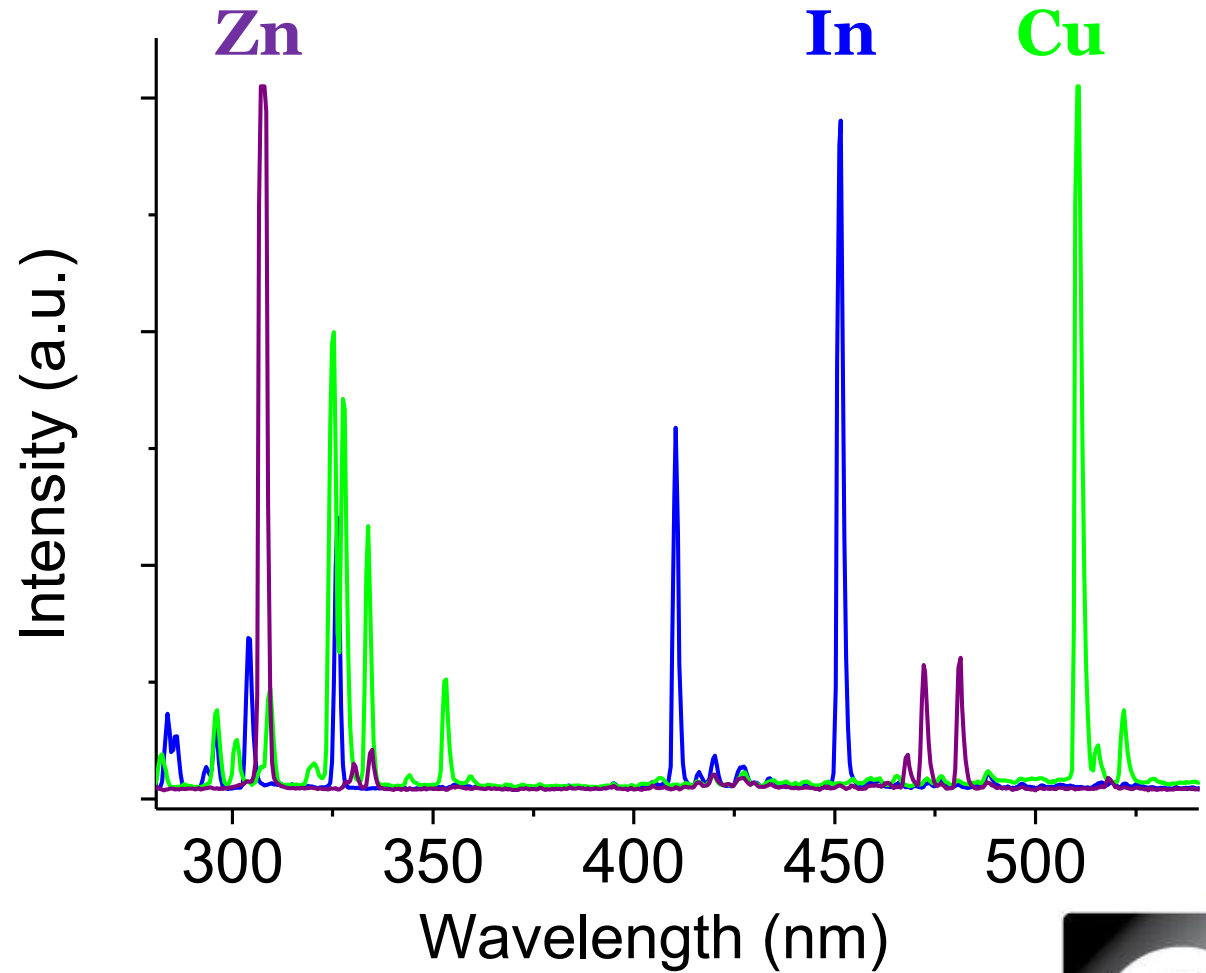
In



Cu



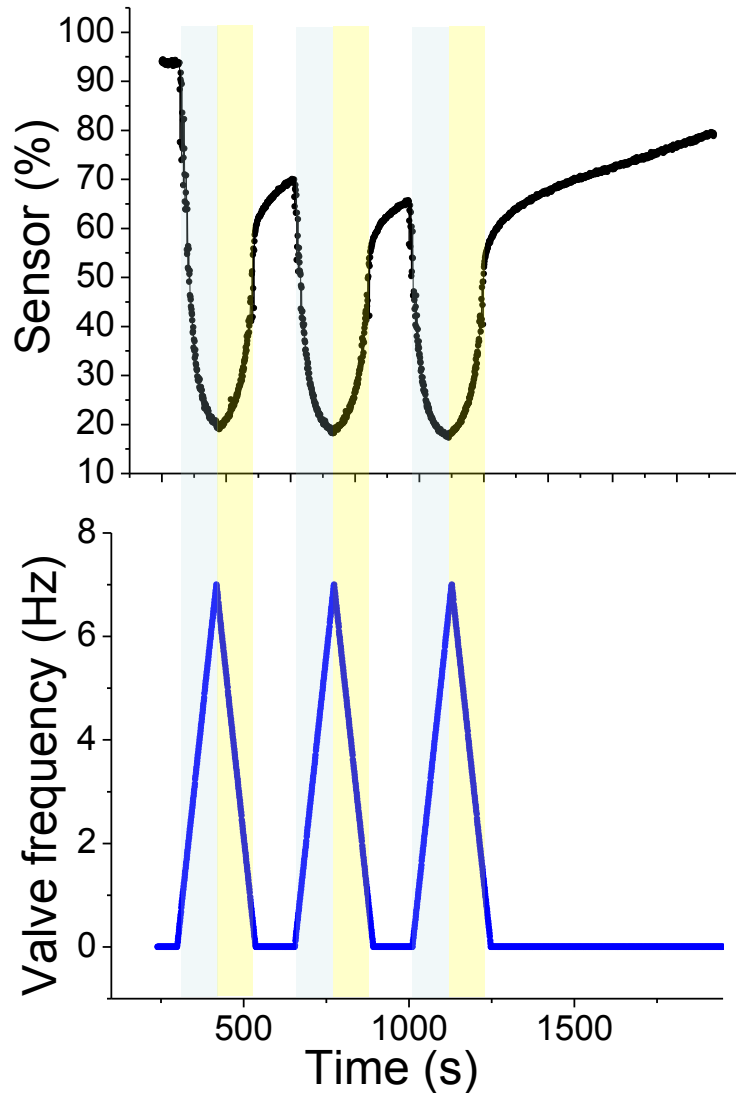
Zn



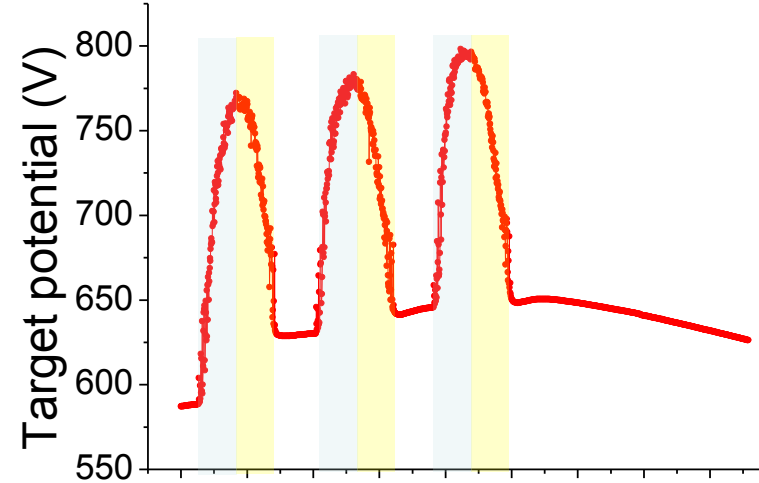
Hysteresis ramps: P.E.M. & target voltage for the Indium & Sulphur system

gencoa: perfect your process

λ Sensor (CCD) = 451.7nm (In)



Target potential



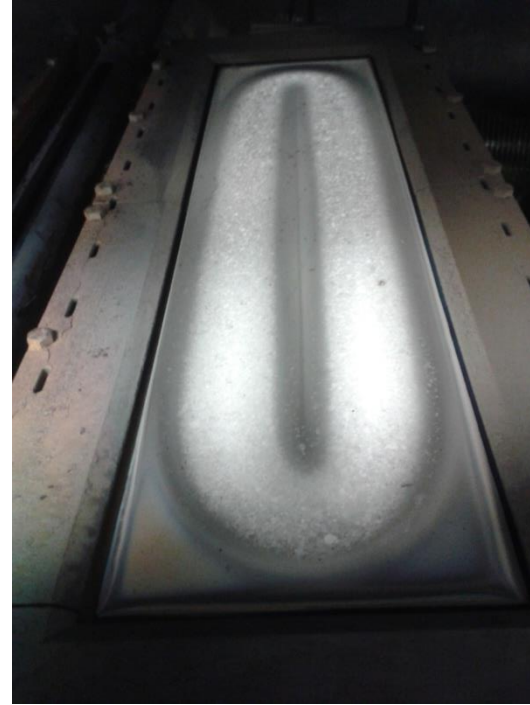
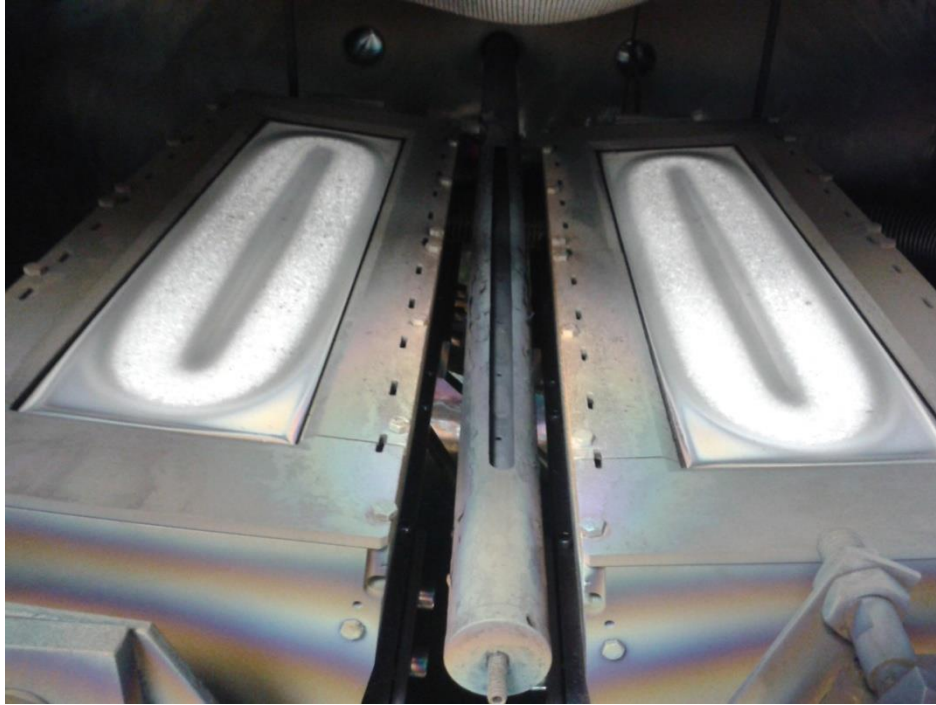
In / S



Indium target (In) + Sulphur (S) – target displays classical

genco: perfect your process

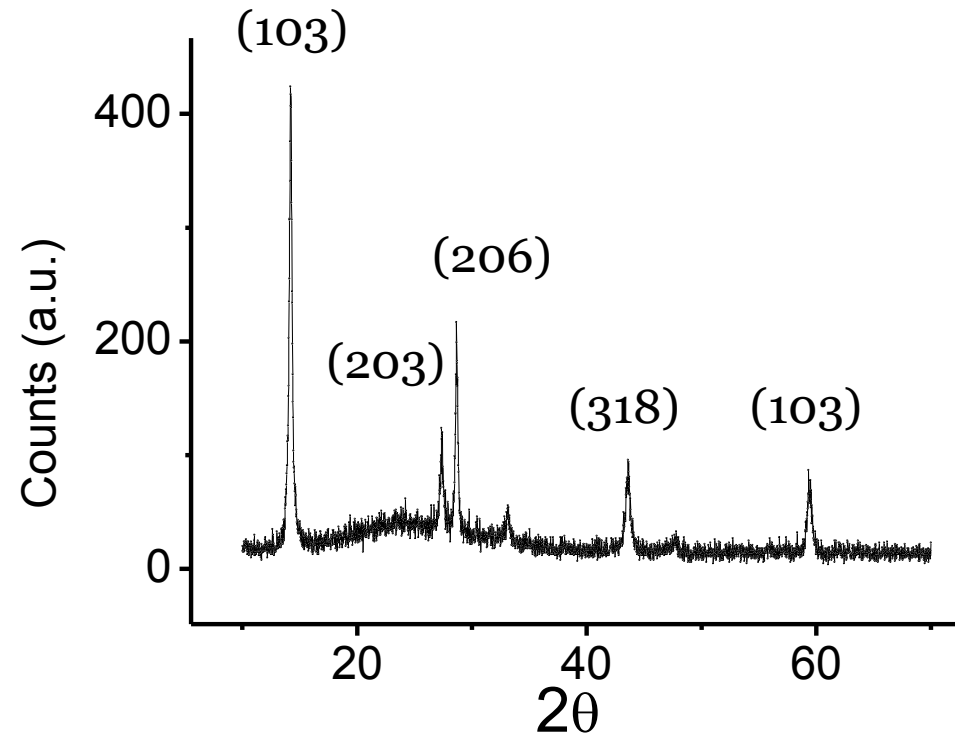
transition mode appearance



In



relative to earlier FDTD models the
dynamics, or the Pauli Exclusion Principle
this paper is more versatile than
of the electromagnetic field for complex
constructed in photonic crystals or
much complex geometries, the lasing mechanism
to calculate. The present work aims at
the dynamics of the 4-level

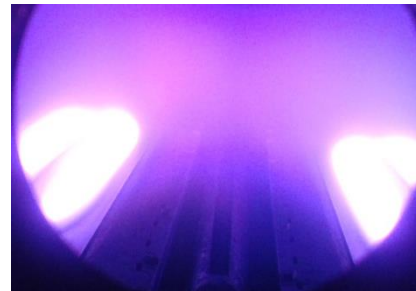
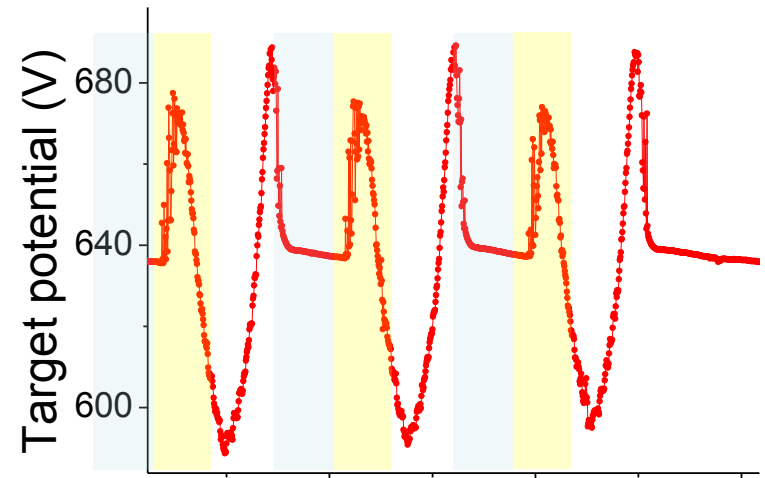
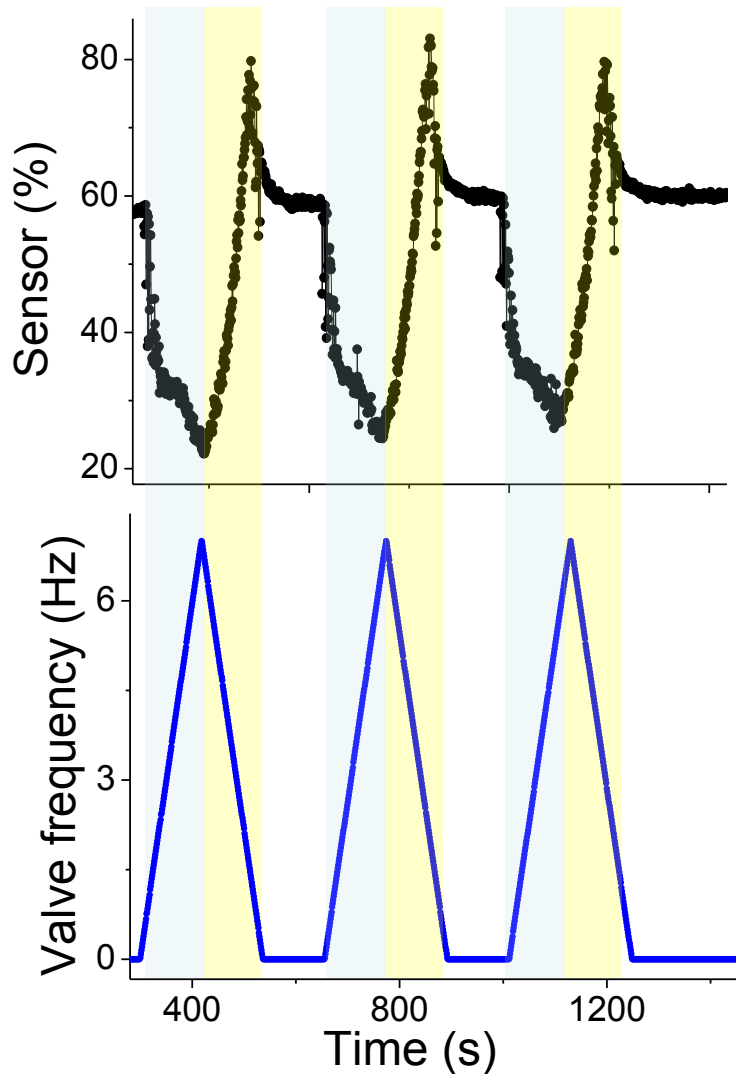


Hysteresis ramps: P.E.M. & target voltage for the Zinc & Sulphur system

gencoa: perfect your process

λ Sensor (CCD) = 307.4nm
(Zn)

Target potential



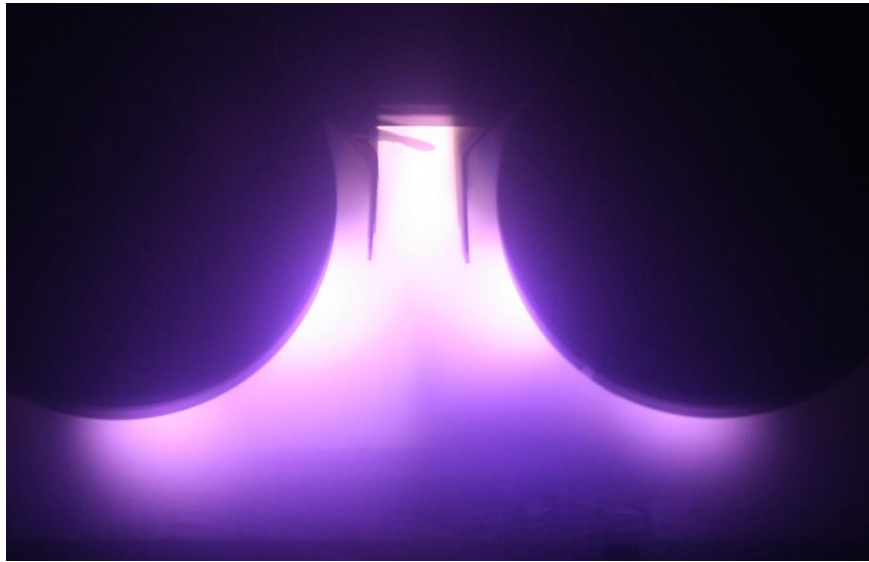
Zn / S



The control process is good and rotatable magnetrons are better for

gencoa: perfect your process

cleanliness and productivity



- A rotating target is self-cleaning so is an easier process to control compared to planar type targets
- Rotating targets offer higher rates and longer lifetimes
- CuGa, CuIn, CuInGa, In, Zn rotatable targets are readily available



gencoa: perfect your process

- A fast feedback process for reactive sputtering of several layers in a CIGS cell has been shown
- CuInGa, Zn, In elements can be combined with both S and Se with a high degree of control and in varying combinations
- This technology makes the highly developed graded structures possible that will be required to improve cell efficiency
- The 2nd stage selenization / sulphurization can be removed
- A single stage purely sputtered cell is readily achievable with non-reactive and reactive sputtering

References attributed to Niki et al, Prog. Photovolt. Res. Appl. 2010 **18** 453-466



Thank you for listening and acknowledgments

gencoa: perfect your process



Victor Bellido-González
Dermot Monaghan
Benoit Daniel
Joseph Brindley



Fernando Briones



POLITÉCNICA

Raquel Gonzalez,
Pedro Melgar

nano4ENERGY

Ambiörn Wennberg
Ivan Fernandez

**Employment opportunities exist at
Gencoa for people with good
scientific backgrounds or with
plasma knowledge.**

